

L Number	Hits	Search Text	DB	Time stamp
2	0	(wafer adj (bond\$3 or attach\$3) near4	USPAT;	2002/12/19 14:06
		(dielectric adj (layer or film))) same	US-PGPUB;	1
		test\$3 same (cut\$4 or dic\$3 or separat\$3)	EPO; JPO;	
			DERWENT;	1
		/ 5 1' /b - 102	IBM_TDB USPAT;	2002/12/19 14:07
3	0	(wafer adj (bond\$3 or attach\$3) near4 (dielectric adj (layer or film))) same	US-PGPUB;	2002/12/19 14:07
		test\$3 same (cut\$4 or dic\$3 or separat\$3)	EPO; JPO;	
		testas same (cataa of dicas of separates)	DERWENT;	i
			IBM TDB	
1	19	wafer adj (bond\$3 or attach\$3) near4	USPAT;	2002/12/19 14:07
		(dielectric adj (layer or film))	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	_		IBM_TDB	0000/10/10 14 00
4	0	(wafer adj (bond\$3 or attach\$3) near4	USPAT;	2002/12/19 14:38
		(dielectric adj (layer or film))) same	US-PGPUB; EPO; JPO;	
	! !	test\$3	DERWENT;	
			IBM TDB	
5	963	438/15,110,113,114.ccls.	USPAT	2002/12/19 14:38
6	1212	438/15,110,113,114.ccls.	USPAT;	2002/12/19 14:38
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
•			IBM_TDB	
7	0	438/15,110,113,114.ccls. and ((wafer adj	USPAT;	2002/12/19 14:40
		(bond\$3 or attach\$3) near4 (dielectric adj	US-PGPUB;	
		(layer or film))) same test\$3)	EPO; JPO; DERWENT;	
			IBM TDB	
_	348	(438/15).CCLS.	USPAT	2002/07/03 08:58
_	258	(438/113).CCLS.	USPAT	2002/07/03 08:58
_	94	(438/110).CCLS.	USPAT	2002/07/03 08:58
_	59	(438/114).CCLS.	USPAT	2002/07/03 08:58
_	681	438/15,110,113,114.ccls.	USPAT	2002/12/19 14:38
_	401	438/15,110,113,114.ccls. and test\$3	USPAT	2001/08/07 15:09
-	272	(438/15,110,113,114.ccls. and test\$3) and	USPAT	2001/08/07 15:10
	001	(dice\$4 or cut\$5)	HCDAM.	2002/02/04 09:53
-	901	438/15,110,113,114.ccls.	USPAT; EPO; JPO;	2002/02/04 09:55
			DERWENT	
_	460	438/15,110,113,114.ccls. and test\$3	USPAT;	2002/02/04 09:54
	1.00		EPO; JPO;	
			DERWENT	
-	325	(438/15,110,113,114.ccls. and test\$3) and	USPAT;	2002/02/05 08:26
		(dic\$5 or cut\$5)	EPO; JPO;	
	_	(	DERWENT	0000/00/05 03 10
-	5	(("6077757") or ("6335224") or ("6309943")	USPAT	2002/02/05 07:19
_	7	or ("6309909") or ("6326697")).PN.   (("6077757") or ("6335224") or ("6309943")	USPAT	2002/02/05 09:49
_	<b>'</b>	or ("6309909") or ("6326697") or	USFAI	2002/02/03 09:49
		("5858815") or ("5137836")).PN.		
_	326	(438/15,110,113,114.ccls. and test\$3) and	USPAT;	2002/02/05 08:28
	523	(dic\$5 or cut\$5)	EPO; JPO;	
		• • • • • • • • • • • • • • • • • • • •	DERWENT	
-	0		USPAT;	2002/02/05 08:33
		(dic\$5 or cut\$5) ) and (magnet\$7 adj	EPO; JPO;	
		align\$5)	DERWENT	0000/00/125 20 25
-	170	((438/15,110,113,114.ccls. and test\$3) and	USPAT;	2002/02/05 08:32
		(dic\$5 or cut\$5) ) and (align\$5)	EPO; JPO;	
_	2705	  magnet\$7 adj align\$5	DERWENT USPAT;	2002/02/05 08:56
_	2705	magnetar adj alighas	EPO; JPO;	2002/02/03 08:36
			DERWENT	
		1	1	1
-	0	(magnet\$7 adj align\$5) and (wafer adj20	USPAT;	2002/02/05 08:37
-	0	(magnet\$7 adj align\$5) and (wafer adj20 dielectric adj tape)	USPAT; EPO; JPO;	2002/02/05 08:37



-	0	wafer adj20 dielectric adj tape	USPAT;	2002/02/05 08:37
ĺ			EPO; JPO;	
			DERWENT	
-	0	wafer adj dielectric adj tape	USPAT;	2002/02/05 08:38
			EPO; JPO;	
			DERWENT	
-	248	(magnet\$7 adj align\$5) and semiconductor	USPAT;	2002/02/05 08:57
			EPO; JPO;	
	i		DERWENT	1
-	0	((magnet\$7 adj align\$5) and ring) and	USPAT;	2002/02/05 08:49
		(charged adj slot)	EPO; JPO;	i
			DERWENT	}
-	0	(magnet\$7 adj align\$5) and (charged adj	USPAT;	2002/02/05 08:49
		slot)	EPO; JPO;	
			DERWENT	
-	613	(magnet\$7 adj align\$5) and ring	USPAT;	2002/02/05 08:50
	}		EPO; JPO;	İ
			DERWENT	
-	47	1	USPAT;	2002/02/05 08:51
		semiconductor	EPO; JPO;	
			DERWENT	
-	3066	optically adj align\$5	USPAT;	2002/02/05 08:56
			EPO; JPO;	
!			DERWENT	
-	612	(optically adj align\$5) and semiconductor	USPAT;	2002/02/05 08:57
	1		EPO; JPO;	
			DERWENT	
-	8	(	USPAT	2002/02/05 09:49
		or ("6309909") or ("6326697") or		
	}	("5858815") or ("5137836") or		1
	İ	("4781969")).PN.		
-	10260	wood.inv.	USPAT;	2002/07/03 08:13
	i		US-PGPUB;	
			EPO; JPO;	}
			DERWENT;	
			IBM TDB	i i
-	539	wood.inv. and alan	USPAT;	2002/07/03 08:13
			US-PGPUB;	2002, 07, 00 00.10
			EPO; JPO;	
	l		DERWENT;	
			IBM TDB	
-	232	(wood.inv. and alan) and (micron adj	USPAT;	2002/07/03 08:14
		technology)	US-PGPUB:	
	]	<del></del>	EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	1	("6268650").PN.	USPĀT	2002/07/03 08:30
-	425	(438/15).CCLS.	USPAT	2002/07/08 08:43
-	331	(438/113).CCLS.	USPAT	2002/07/08 08:57
-	140	(438/110).CCLS.	USPAT	2002/07/08 08:57
-	90	(438/114).CCLS.	USPAT	2002/07/08 08:57
i <b>-</b> .	425	(438/15).CCLS.	USPAT	2002/07/08 08:37
-	331	(438/113).CCLS.	USPAT	2002/07/08 08:57
-	140	(438/110).CCLS.	USPAT	2002/07/08 08:57
-	90	(438/114).CCLS.	USPAT	2002/07/08 08:37 2002/07/08 14:32
-	13 [	(("6389689") or ("5977629") or ("5796170")	USPAT	2002/07/08 14:32
		or ("6326700") or ("6268650") or		2002/01/00 10.33
l		("5858815") or ("5817535") or ("5770032")		
		or ("4781969") or ("5073840") or		
	ŀ	("5696033") or ("5834839") or	į	l i
		("6160714")).PN.		
-	8	(("6309909") or ("5858815") or ("5137836")	USPAT	2002/07/09 09:56
		or ("6077757") or ("6326697") or	001111	2002/07/09 09:56
		("6165885") or ("5834320") or		
		("4781969")).PN.		